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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	360
Number of Logic Elements/Cells	2880
Total RAM Bits	20480
Number of I/O	189
Number of Gates	116000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	240-BFQFP
Supplier Device Package	240-PQFP (32x32)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf10k50vqi240-2

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



For more information, see the following documents:

- Configuration Devices for APEX & FLEX Devices Data Sheet
- BitBlaster Serial Download Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- Application Note 116 (Configuring APEX 20K, FLEX 10K & FLEX 6000 Devices)

FLEX 10K devices are supported by Altera development systems; single, integrated packages that offer schematic, text (including AHDL), and waveform design entry, compilation and logic synthesis, full simulation and worst-case timing analysis, and device configuration. The Altera software provides EDIF 2 0 0 and 3 0 0, LPM, VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools.

The Altera software works easily with common gate array EDA tools for synthesis and simulation. For example, the Altera software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the Altera software contains EDA libraries that use device-specific features such as carry chains which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the Altera development systems include DesignWare functions that are optimized for the FLEX 10K architecture.

The Altera development systems run on Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations.



See the MAX+PLUS II Programmable Logic Development System & Software Data Sheet for more information.

Functional Description

Each FLEX 10K device contains an embedded array to implement memory and specialized logic functions, and a logic array to implement general logic.

The embedded array consists of a series of EABs. When implementing memory functions, each EAB provides 2,048 bits, which can be used to create RAM, ROM, dual-port RAM, or first-in first-out (FIFO) functions. When implementing logic, each EAB can contribute 100 to 600 gates towards complex logic functions, such as multipliers, microcontrollers, state machines, and DSP functions. EABs can be used independently, or multiple EABs can be combined to implement larger functions.

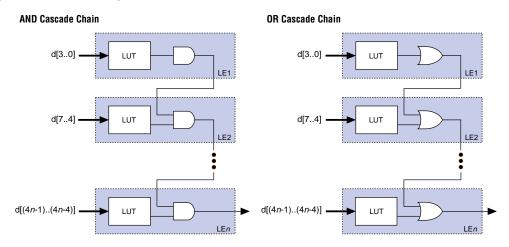
Cascade Chain

With the cascade chain, the FLEX 10K architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.7 ns per LE. Cascade chain logic can be created automatically by the Compiler during design processing, or manually by the designer during design entry.

Cascade chains longer than eight bits are implemented automatically by linking several LABs together. For easier routing, a long cascade chain skips every other LAB in a row. A cascade chain longer than one LAB skips either from even-numbered LAB to even-numbered LAB, or from odd-numbered LAB to odd-numbered LAB (e.g., the last LE of the first LAB in a row cascades to the first LE of the third LAB). The cascade chain does not cross the center of the row (e.g., in the EPF10K50 device, the cascade chain stops at the eighteenth LAB and a new one begins at the nineteenth LAB). This break is due to the EAB's placement in the middle of the row.

Figure 8 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. The LE delay is as low as 1.6 ns; the cascade chain delay is as low as 0.7 ns. With the cascade chain, 3.7 ns is needed to decode a 16-bit address.





Normal Mode

The normal mode is suitable for general logic applications and wide decoding functions that can take advantage of a cascade chain. In normal mode, four data inputs from the LAB local interconnect and the carry-in are inputs to a four-input LUT. The Compiler automatically selects the carry-in or the DATA3 signal as one of the inputs to the LUT. The LUT output can be combined with the cascade-in signal to form a cascade chain through the cascade-out signal. Either the register or the LUT can be used to drive both the local interconnect and the FastTrack Interconnect at the same time.

The LUT and the register in the LE can be used independently; this feature is known as register packing. To support register packing, the LE has two outputs; one drives the local interconnect and the other drives the FastTrack Interconnect. The DATA4 signal can drive the register directly, allowing the LUT to compute a function that is independent of the registered signal; a three-input function can be computed in the LUT, and a fourth independent signal can be registered. Alternatively, a four-input function can be generated, and one of the inputs to this function can be used to drive the register. The register in a packed LE can still use the clock enable, clear, and preset signals in the LE. In a packed LE, the register can drive the FastTrack Interconnect while the LUT drives the local interconnect, or vice versa.

Arithmetic Mode

The arithmetic mode offers 2 three-input LUTs that are ideal for implementing adders, accumulators, and comparators. One LUT computes a three-input function, and the other generates a carry output. As shown in Figure 9 on page 19, the first LUT uses the carry-in signal and two data inputs from the LAB local interconnect to generate a combinatorial or registered output. For example, in an adder, this output is the sum of three signals: a, b, and carry-in. The second LUT uses the same three signals to generate a carry-out signal, thereby creating a carry chain. The arithmetic mode also supports simultaneous use of the cascade chain.

Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load, or with an asynchronous clear. If DATA3 is tied to V_{CC} , asserting LABCTRL1 asynchronously loads a one into the register. Alternatively, the Altera software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

Asynchronous Preset & Clear

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. DATA3 is tied to V_{CC} , therefore, asserting LABCTRL1 asynchronously loads a one into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

Asynchronous Load with Clear

When implementing an asynchronous load in conjunction with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear; LABCTRL2 does not have to feed the preset circuits.

Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with preset, the Altera software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 presets the register, while asserting LABCTRL1 loads the register. The Altera software inverts the signal that drives DATA3 to account for the inversion of the register's output.

Asynchronous Load without Preset or Clear

When implementing an asynchronous load without preset or clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

Figure 12 shows the interconnection of adjacent LABs and EABs with row, column, and local interconnects, as well as the associated cascade and carry chains. Each LAB is labeled according to its location: a letter represents the row and a number represents the column. For example, LAB B3 is in row B, column 3.

Figure 12. Interconnect Resources

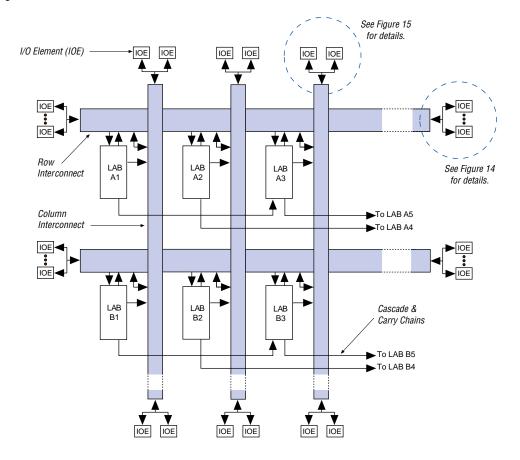


Table 15. 32-Bit FLEX 10K Device	e IDCODE	Note (1)								
Device	IDCODE (32 Bits)									
	Version (4 Bits)	Part Number (16 Bits)	Manufacturer's Identity (11 Bits)	1 (1 Bit) (2)						
EPF10K10, EPF10K10A	0000	0001 0000 0001 0000	00001101110	1						
EPF10K20	0000	0001 0000 0010 0000	00001101110	1						
EPF10K30, EPF10K30A	0000	0001 0000 0011 0000	00001101110	1						
EPF10K40	0000	0001 0000 0100 0000	00001101110	1						
EPF10K50, EPF10K50V	0000	0001 0000 0101 0000	00001101110	1						
EPF10K70	0000	0001 0000 0111 0000	00001101110	1						
EPF10K100, EPF10K100A	0000	0000 0001 0000 0000	00001101110	1						
EPF10K130V	0000	0000 0001 0011 0000	00001101110	1						
EPF10K250A	0000	0000 0010 0101 0000	00001101110	1						

Notes:

- (1) The most significant bit (MSB) is on the left.
- (2) The least significant bit (LSB) for all JTAG IDCODEs is 1.

FLEX 10K devices include weak pull-ups on JTAG pins.



For more information, see the following documents:

- Application Note 39 (IEEE 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices)
- BitBlaster Serial Download Cable Data Sheet
- ByteBlasterMV Parallel Port Download Cable Data Sheet
- Jam Programming & Test Language Specification

Table 1	9. FLEX 10K 5.0-V Devi	ce DC Operating Conditions No	tes (5), (6)			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IH}	High-level input voltage		2.0		V _{CCINT} + 0.5	V
V _{IL}	Low-level input voltage		-0.5		0.8	V
V _{OH}	5.0-V high-level TTL output voltage	$I_{OH} = -4 \text{ mA DC}, V_{CCIO} = 4.75 \text{ V}$ (7)	2.4			V
	3.3-V high-level TTL output voltage	$I_{OH} = -4 \text{ mA DC}, V_{CCIO} = 3.00 \text{ V}$ (7)	2.4			V
	3.3-V high-level CMOS output voltage	$I_{OH} = -0.1 \text{ mA DC}, V_{CCIO} = 3.00 \text{ V}$ (7)	V _{CCIO} - 0.2			V
V _{OL}	5.0-V low-level TTL output voltage	I_{OL} = 12 mA DC, V_{CCIO} = 4.75 V (8)			0.45	V
	3.3-V low-level TTL output voltage	I_{OL} = 12 mA DC, V_{CCIO} = 3.00 V (8)			0.45	V
	3.3-V low-level CMOS output voltage	$I_{OL} = 0.1 \text{ mA DC}, V_{CCIO} = 3.00 \text{ V}$ (8)			0.2	V
I _I	Input pin leakage current	V _I = V _{CC} or ground (9)	-10		10	μΑ
I _{OZ}	Tri-stated I/O pin leakage current	$V_O = V_{CC}$ or ground (9)	-40		40	μΑ
I _{CC0}	V _{CC} supply current (standby)	V _I = ground, no load		0.5	10	mA

Table 2	O. 5.0-V Device Capacitance of	EPF10K10, EPF10K20 & EPF10K30	O Devices	Note (10)	
Symbol	Parameter	Conditions	Min	Max	Unit
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		8	pF
C _{INCLK}	Input capacitance on dedicated clock pin	V _{IN} = 0 V, f = 1.0 MHz		12	pF
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		8	pF

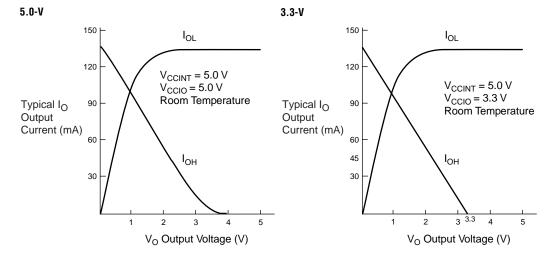
Table 2	1. 5.0-V Device Capacitance of I	EPF10K40, EPF10K50, EPF10K70 &	EPF10K100 D	Devices Note	(10)
Symbol	Parameter	Conditions	Min	Max	Unit
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF
C _{INCLK}	Input capacitance on dedicated clock pin	V _{IN} = 0 V, f = 1.0 MHz		15	pF
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF

Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage is -0.5 V. During transitions, the inputs may undershoot to -2.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4) Maximum V_{CC} rise time is 100 ms. V_{CC} must rise monotonically.
- (5) Typical values are for $T_A = 25^{\circ}$ C and $V_{CC} = 5.0$ V.
- (6) These values are specified under the Recommended Operation Condition shown in Table 18 on page 45.
- (7) The I_{OH} parameter refers to high-level TTL or CMOS output current.
- (8) The I_{OL} parameter refers to low-level TTL or CMOS output current. This parameter applies to open-drain pins as well as output pins.
- (9) This value is specified for normal device operation. The value may vary during power-up.
- (10) Capacitance is sample-tested only.

Figure 20 shows the typical output drive characteristics of FLEX 10K devices with 5.0-V and 3.3-V $V_{\rm CCIO}$. The output driver is compliant with the 5.0-V *PCI Local Bus Specification, Revision 2.2* (for 5.0-V $V_{\rm CCIO}$).

Figure 20. Output Drive Characteristics of FLEX 10K Devices



Notes to tables:

- Microparameters are timing delays contributed by individual architectural elements. These parameters cannot be measured explicitly.
- (2) Operating conditions: $V_{CCIO} = 5.0 \text{ V} \pm 5\%$ for commercial use in FLEX 10K devices.

 V_{CCIO} = 5.0 V ± 10% for industrial use in FLEX 10K devices.

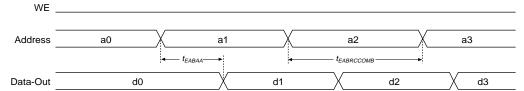
 $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial or industrial use in FLEX 10KA devices.

- (3) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial or industrial use in FLEX 10K devices.
 - V_{CCIO} = 2.5 V ± 0.2 V for commercial or industrial use in FLEX 10KA devices.
- (4) Operating conditions: $V_{CCIO} = 2.5 \text{ V}$, 3.3 V, or 5.0 V.
- (5) Because the RAM in the EAB is self-timed, this parameter can be ignored when the WE signal is registered.
- (6) EAB macroparameters are internal parameters that can simplify predicting the behavior of an EAB at its boundary; these parameters are calculated by summing selected microparameters.
- (7) These parameters are worst-case values for typical applications. Post-compilation timing simulation and timing analysis are required to determine actual worst-case performance.
- (8) External reference timing parameters are factory-tested, worst-case values specified by Altera. A representative subset of signal paths is tested to approximate typical device applications.
- (9) Contact Altera Applications for test circuit specifications and test conditions.
- (10) These timing parameters are sample-tested only.

Figures 29 and 30 show the asynchronous and synchronous timing waveforms, respectively, for the EAB macroparameters in Table 34.

Figure 29. EAB Asynchronous Timing Waveforms

EAB Asynchronous Read



EAB Asynchronous Write

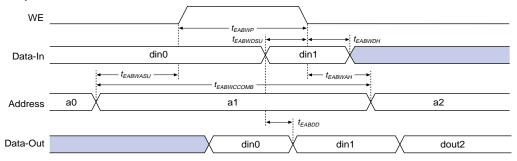
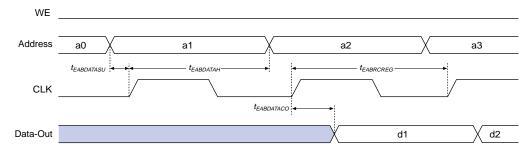
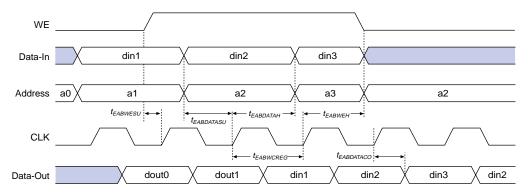


Figure 30. EAB Synchronous Timing Waveforms

EAB Synchronous Read



EAB Synchronous Write (EAB Output Registers Used)



• • • •	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		-4 Speed Grade		Unit
Symbol	-1 Spee	d Grade	-2 Spee	d Grade	-3 Spe	ed Grade	-4 Spee	ed Grade	Unit
	Min	Max	Min	Max	Min	Max	Min	Max	
t _{EABDATA1}		1.7		2.8		3.4		4.6	ns
t _{EABDATA2}		4.9		3.9		4.8		5.9	ns
t _{EABWE1}		0.0		2.5		3.0		3.7	ns
t _{EABWE2}		4.0		4.1		5.0		6.2	ns
t _{EABCLK}		0.4		0.8		1.0		1.2	ns
t _{EABCO}		0.1		0.2		0.3		0.4	ns
t _{EABBYPASS}		0.9		1.1		1.3		1.6	ns
t _{EABSU}	0.8		1.5		1.8		2.2		ns
t _{EABH}	0.8		1.6		2.0		2.5		ns
t_{AA}		5.5		8.2		10.0		12.4	ns
t_{WP}	6.0		4.9		6.0		7.4		ns
t _{WDSU}	0.1		0.8		1.0		1.2		ns
t _{WDH}	0.1		0.2		0.3		0.4		ns
t _{WASU}	0.1		0.4		0.5		0.6		ns
t _{WAH}	0.1		0.8		1.0		1.2		ns
t_{WO}		2.8		4.3		5.3		6.5	ns
t_{DD}		2.8		4.3		5.3		6.5	ns
t _{EABOUT}		0.5		0.4		0.5		0.6	ns
t _{EABCH}	2.0		4.0		4.0		4.0		ns
t _{EABCL}	6.0		4.9		6.0		7.4		ns

Table 74. EPF	10K50V De	evice EAB I	Internal Til	ming Macı	oparamete	ers Not	re (1)		
Symbol	-1 Speed Grade		-2 Spee	-2 Speed Grade		-3 Speed Grade		-4 Speed Grade	
	Min	Max	Min	Max	Min	Max	Min	Max	
t _{EABAA}		9.5		13.6		16.5		20.8	ns
t _{EABRCCOMB}	9.5		13.6		16.5		20.8		ns
t _{EABRCREG}	6.1		8.8		10.8		13.4		ns
t _{EABWP}	6.0		4.9		6.0		7.4		ns
t _{EABWCCOMB}	6.2		6.1		7.5		9.2		ns
t _{EABWCREG}	12.0		11.6		14.2		17.4		ns
t _{EABDD}		6.8		9.7		11.8		14.9	ns
t _{EABDATA} CO		1.0		1.4		1.8		2.2	ns
t _{EABDATASU}	5.3		4.6		5.6		6.9		ns
t _{EABDATAH}	0.0		0.0		0.0		0.0		ns
t _{EABWESU}	4.4		4.8		5.8		7.2		ns
t _{EABWEH}	0.0		0.0		0.0		0.0		ns
t _{EABWDSU}	1.8		1.1		1.4		2.1		ns
t _{EABWDH}	0.0		0.0		0.0		0.0		ns
t _{EABWASU}	4.5		4.6		5.6		7.4		ns
t _{EABWAH}	0.0		0.0		0.0		0.0		ns
t _{EABWO}		5.1		9.4		11.4		14.0	ns

Notes to tables:

- (1) All timing parameters are described in Tables 32 through 38 in this data sheet.
- (2) Using an LE to register the signal may provide a lower setup time.
- (3) This parameter is specified by characterization.

Tables 85 through 91 show EPF10K10A device internal and external timing parameters.

Symbol	1 Snoo	d Grade	2 Snoo	d Grado	2 Cno/	ed Grade	Unit
Syllibul	-1 Shee	u Graue	-2 Spec	-2 Speed Grade		eu Graue	UIII
	Min	Max	Min	Max	Min	Max	
t _{LUT}		0.9		1.2		1.6	ns
t _{CLUT}		1.2		1.4		1.9	ns
t _{RLUT}		1.9		2.3		3.0	ns
t _{PACKED}		0.6		0.7		0.9	ns
t _{EN}		0.5		0.6		0.8	ns
t _{CICO}		02		0.3		0.4	ns
t _{CGEN}		0.7		0.9		1.1	ns
t _{CGENR}		0.7		0.9		1.1	ns
t _{CASC}		1.0		1.2		1.7	ns
t _C		1.2		1.4		1.9	ns
$t_{\rm CO}$		0.5		0.6		0.8	ns
t_{COMB}		0.5		0.6		0.8	ns
t _{SU}	1.1		1.3		1.7		ns
t _H	0.6		0.7		0.9		ns
t _{PRE}		0.5		0.6		0.9	ns
t _{CLR}		0.5		0.6		0.9	ns
t _{CH}	3.0		3.5		4.0	_	ns
t_{CL}	3.0		3.5		4.0		ns

Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		d Grade	Unit
	Min	Max	Min	Max	Min	Max	
		1.3		1.5		2.0	ns
ioc		0.2		0.3		0.3	ns
ioco		0.2		0.3		0.4	ns
^t іосомв		0.6		0.7		0.9	ns
t _{iosu}	0.8		1.0		1.3		ns

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Spee	Unit	
oy	Min	Max	Min	Max	Min	Max	
t _{EABAA}		8.1		9.8		13.1	ns
t _{EABRCCOMB}	8.1		9.8		13.1		ns
t _{EABRCREG}	5.8		6.9		9.3		ns
t _{EABWP}	2.0		2.4		3.2		ns
t _{EABWCCOMB}	3.5		4.2		5.6		ns
t _{EABWCREG}	9.4		11.2		14.8		ns
t _{EABDD}		6.9		8.3		11.0	ns
t _{EABDATACO}		1.3		1.5		2.0	ns
t _{EABDATASU}	2.4		3.0		3.9		ns
t _{EABDATAH}	0.0		0.0		0.0		ns
t _{EABWESU}	4.1		4.9		6.5		ns
t _{EABWEH}	0.0		0.0		0.0		ns
t _{EABWDSU}	1.4		1.6		2.2		ns
t _{EABWDH}	0.0		0.0	_	0.0		ns
t _{EABWASU}	2.5		3.0	_	4.1		ns
t _{EABWAH}	0.0		0.0		0.0		ns
t _{EABWO}		6.2		7.5		9.9	ns

Symbol	-1 Spee	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		
	Min	Max	Min	Max	Min	Max		
t_{IOH}	0.9		1.1		1.4		ns	
t _{IOCLR}		0.7		0.8		1.0	ns	
t _{OD1}		1.9		2.2		2.9	ns	
t _{OD2}		4.8		5.6		7.3	ns	
tod3		7.0		8.2		10.8	ns	
XZ		2.2		2.6		3.4	ns	
ZX1		2.2		2.6		3.4	ns	
ZX2		5.1		6.0		7.8	ns	
ZX3		7.3		8.6		11.3	ns	
INREG		4.4		5.2		6.8	ns	
IOFD		3.8		4.5		5.9	ns	
t _{INCOMB}		3.8		4.5		5.9	ns	

Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t _{EABAA}		9.7		11.6		16.2	ns
t _{EABRCCOMB}	9.7		11.6		16.2		ns
t _{EABRCREG}	5.9		7.1		9.7		ns
t _{EABWP}	3.8		4.5		5.9		ns
t _{EABWCCOMB}	4.0		4.7		6.3		ns
t _{EABWCREG}	9.8		11.6		16.6		ns
t _{EABDD}		9.2		11.0		16.1	ns
^t EABDATACO		1.7		2.1		3.4	ns
t _{EABDATASU}	2.3		2.7		3.5		ns
t _{EABDATAH}	0.0		0.0		0.0		ns
t _{EABWESU}	3.3		3.9		4.9		ns
t _{EABWEH}	0.0		0.0		0.0		ns
t _{EABWDSU}	3.2		3.8		5.0		ns
t _{EABWDH}	0.0		0.0		0.0		ns
t _{EABWASU}	3.7		4.4		5.1		ns
t _{EABWAH}	0.0		0.0		0.0		ns
t _{EABWO}		6.1		7.3		11.3	ns

Symbol	-1 Speed Grade		-2 Spee	d Grade	-3 Speed Grade		Unit
	Min	Max	Min	Max	Min	Max	
t_{IOD}		2.5		2.9		3.4	ns
t_{IOC}		0.3		0.3		0.4	ns
t_{IOCO}		0.2		0.2		0.3	ns
t_{IOCOMB}		0.5		0.6		0.7	ns
t_{IOSU}	1.3		1.7		1.8		ns
t_{IOH}	0.2		0.2		0.3		ns
t _{IOCLR}		1.0		1.2		1.4	ns
t_{OD1}		2.2		2.6		3.0	ns
t_{OD2}		4.5		5.3		6.1	ns
t _{OD3}		6.8		7.9		9.3	ns
t_{XZ}		2.7		3.1		3.7	ns
t_{ZX1}		2.7		3.1		3.7	ns
t _{ZX2}		5.0		5.8		6.8	ns
t_{ZX3}		7.3		8.4		10.0	ns
t _{INREG}		5.3		6.1		7.2	ns
t _{IOFD}		4.7		5.5		6.4	ns
t _{INCOMB}		4.7		5.5		6.4	ns

Symbol	-1 Speed Grade		-2 Spee	d Grade	-3 Spee	Unit	
	Min	Max	Min	Max	Min	Max	
t _{DIN2IOE}		4.8		5.4		6.0	ns
t _{DIN2LE}		2.0		2.4		2.7	ns
t _{DIN2DATA}		2.4		2.7		2.9	ns
t _{DCLK2IOE}		2.6		3.0		3.5	ns
t _{DCLK2LE}		2.0		2.4		2.7	ns
t _{SAMELAB}		0.1		0.1		0.1	ns
t _{SAMEROW}		1.5		1.7		1.9	ns
t _{SAME} COLUMN		5.5		6.5		7.4	ns
t _{DIFFROW}		7.0		8.2		9.3	ns
t _{TWOROWS}		8.5		9.9		11.2	ns
t _{LEPERIPH}		3.9		4.2		4.5	ns
t _{LABCARRY}		0.2		0.2		0.3	ns
t _{LABCASC}		0.4		0.5		0.6	ns

Table 104. EPF10K100A Device External Timing Parameters Note (1)									
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit		
	Min	Max	Min	Max	Min	Max			
t _{DRR}		12.5		14.5		17.0	ns		
t _{INSU} (2), (3)	3.7		4.5		5.1		ns		
t _{INH} (3)	0.0		0.0		0.0		ns		
t _{outco} (3)	2.0	5.3	2.0	6.1	2.0	7.2	ns		

Table 105. EPF10K100A Device External Bidirectional Timing Parameters Note (1)									
Symbol	-1 Speed Grade		-2 Speed Grade		-3 Speed Grade		Unit		
	Min	Max	Min	Max	Min	Max			
t _{INSUBIDIR}	4.9		5.8		6.8		ns		
t _{INHBIDIR}	0.0		0.0		0.0		ns		
toutcobidir	2.0	5.3	2.0	6.1	2.0	7.2	ns		
t _{XZBIDIR}		7.4		8.6		10.1	ns		
t _{ZXBIDIR}		7.4		8.6		10.1	ns		

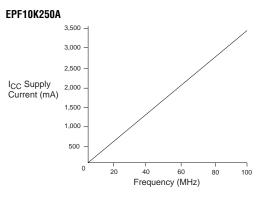


Figure 32. I_{CCACTIVE} vs. Operating Frequency (Part 3 of 3)

Configuration & Operation

The FLEX 10K architecture supports several configuration schemes. This section summarizes the device operating modes and available device configuration schemes.



See *Application Note 116 (Configuring APEX 20K, FLEX 10K & FLEX 6000 Devices)* for detailed descriptions of device configuration options, device configuration pins, and for information on configuring FLEX 10K devices, including sample schematics, timing diagrams, and configuration parameters.

Operating Modes

The FLEX 10K architecture uses SRAM configuration elements that require configuration data to be loaded every time the circuit powers up. The process of physically loading the SRAM data into the device is called *configuration*. Before configuration, as VCC rises, the device initiates a Power-On Reset (POR). This POR event clears the device and prepares it for configuration. The FLEX 10K POR time does not exceed 50 μs .

During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. Together, the configuration and initialization processes are called *command mode*; normal device operation is called *user mode*.



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